

Power 33



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		Parameter					Units	
V _{DS}	Drain to Source Voltage					80	V	
V _{GS}	Gate to	Gate to Source Voltage					V	
I _D	Drain Current -Continuous (Package limited) T _C = 25 °C					20		
	-Continuous (Silicon limited) T _C = 25 °C					30	•	
		-Continuous	T _A	= 25 °C	(Note 1a)	7	Α	
	-Pulsed					30		
E _{AS}	Single P	ngle Pulse Avalanche Energy (Note 3)				72	mJ	
P _D	Power D	wer Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$ 41			41	w		
	Power D	lissipation	T _A	= 25 °C	(Note 1a)	2.3	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range				-55 to +150	°C		
Thermal Ch _{R_{θJC}}		stics Resistance, Junction to Case				3	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)					53		
	arking a	nd Ordering Informatio	n		I			
Device Marking		Device	Package	Re	el Size	Tape Width	Quantity	
FDMC86324		FDMC86324	Power 33		13"	12 mm	3000 units	

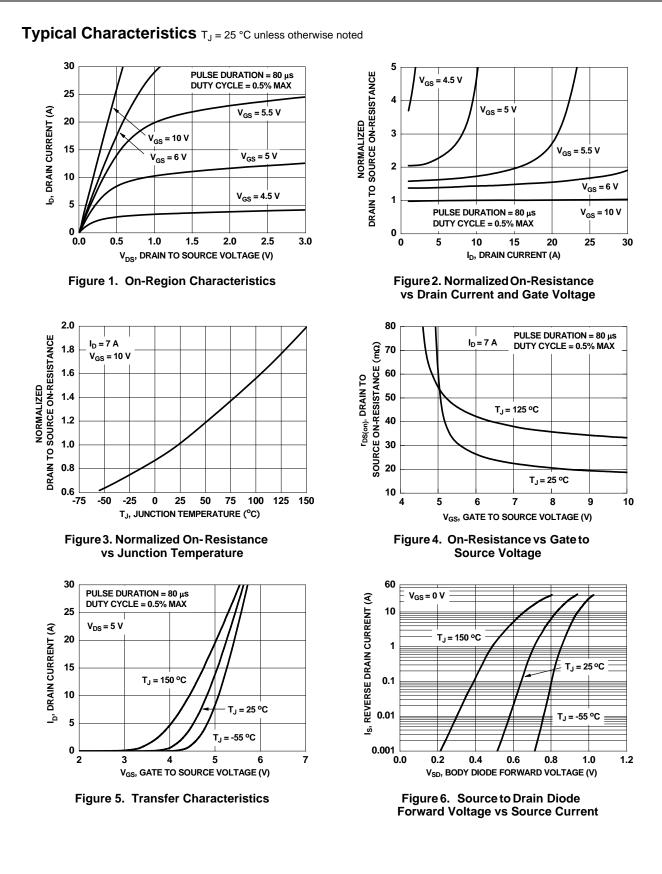
	Test Conditions	Min	Тур	Max	Units
cteristics					
Drain to Source Breakdown Voltage	$I_{\rm D} = 250 \ \mu \text{A}, \ V_{\rm GS} = 0 \ \text{V}$ 80				V
Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		69		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$		1	μA	
Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
teristics					
				4.0	V
Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C	-9		mV/°C	
	$V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$		19.1	23	mΩ
Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 4 A$		25.5	37	
	V_{GS} = 10 V, I_{D} = 7 A, T_{J} = 125 °C		32.5	40	
Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}$			19		S
Characteristics					
			725	965	pF
			175	235	pF
Reverse Transfer Capacitance	t = 1 MHz		15	25	pF
Gate Resistance			0.5		Ω
Characteristics					
			0	17	nc
					ns ns
					ns
					ns
	$V_{oo} = 0 V to 10 V$				nC
	$V_{CS} = 0 V to 5 V$ $V_{DD} = 50 V$				nC
	$I_D = 7 \text{ A}$				nC
-			3.6		nC
rce Diode Characteristics					
	$V_{GS} = 0 V, I_{S} = 7 A$ (Note 2)		0.81	1.3	V
Source to Drain Diode Forward Voltage			0.75	1.2	
Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)				
Source to Drain Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 V, I_S = 2 A$ (Note 2) $I_F = 7 A, di/dt = 100 A/\mu s$		44	70	ns
	Gate to Source Leakage Current teristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Reverse Transfer Capacitance	Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$ Gate to Source Threshold Voltage $I_D = 250 \mu\text{A}, \text{ referenced to } 25 ^{\circ}\text{C}$ Temperature Coefficient $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ Static Drain to Source On Resistance $V_{GS} = 6 \text{ V}, I_D = 4 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}, T_J = 125 ^{\circ}\text{C}$ Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}$ CharacteristicsInput CapacitanceOutput Capacitance $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHzf = 1 MHzCharacteristicsTurn-On Delay TimeRise Time $V_{DD} = 50 \text{ V}, I_D = 7 \text{ A},$ Turn-Off Delay Time $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ Fall Time $V_{GS} = 0 \text{ V to } 10 \text{ V},$ Total Gate Charge $V_{GS} = 0 \text{ V to } 5 \text{ V},$ Total Gate Charge $V_{GS} = 0 \text{ V to } 5 \text{ V},$ Total Gate Charge $V_{GS} = 0 \text{ V to } 5 \text{ V},$ Total Gate Charge $V_{GS} = 0 \text{ V to } 5 \text{ V},$	Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \ \mu\text{A}$ 2.0Gate to Source Threshold Voltage $I_D = 250 \ \mu\text{A}, \text{ referenced to } 25 \ ^{\circ}\text{C}$ 2.0Gate to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ 2.0Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ 2.0Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}$ 2.0Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}$ 2.0CharacteristicsInput Capacitance $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 7 \text{ A}$ CharacteristicsInput CapacitanceInput CapacitanceInput CapacitanceGate ResistanceV_DS = 50 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 7 \text{ A}Input CapacitanceCharacteristicsInput CapacitanceInput CapacitanceInput CapacitanceGate ResistanceV_DD = 50 \text{ V}, I_D = 7 \text{ A}, V_{GS} = 10 \text{ V}, R_{GEN} = 6 \OmegaInput CapacitanceTurn-On Delay TimeInput V_{GS} = 0 \text{ V to 10 V}, V_{DD} = 50 \text{ V}, I_D = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 7 \text{ A}, V_{DD} = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 50 \text{ V}, I_D = 7 \text{ A}, V_{DD} = 7	Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ teristicsGate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}, I_D = 250 \ \mu\text{A}$ 2.03.1Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250 \ \mu\text{A}$, referenced to $25 \ ^{\circ}\text{C}$ -9Static Drain to Source On Resistance $V_{GS} = 10 \ V, I_D = 7 \ \text{A}$ 19.1 $V_{GS} = 6 \ V, I_D = 4 \ \text{A}$ 25.5Forward Transconductance $V_{DD} = 10 \ V, I_D = 7 \ \text{A}$ 19CharacteristicsInput Capacitance Output Capacitance $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_D = 7 \ \text{A}$ 175Reverse Transfer Capacitance $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_T75$ 15Gate Resistance0.515Characteristics0.514Turn-On Delay Time Fall Time $V_{GS} = 10 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD$	Gate to Source Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ ± 100 teristics Gate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250 \mu \text{A}$ 2.0 3.1 4.0 Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250 \mu \text{A}$, referenced to $25 ^{\circ}\text{C}$ -9 $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ 19.1 23 Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$ 25.5 37 Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}, T_J = 125 ^{\circ}\text{C}$ 32.5 40 Forward Transconductance $V_{DD} = 10 \text{ V}, I_D = 7 \text{ A}$ 19 725 965 Output Capacitance $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ 155 25 Gate Resistance 0.5 155 25 Gate Resistance 0.5 155 25 Gate Resistance $0 \text{ D} = 50 \text{ V}, I_D = 7 \text{ A}, V_{CS} = 6 \Omega$ 14 25 Gate Resistance $0 \text{ D} = 50 \text{ V}, R_{GEN} = 6 \Omega$ 14 10 Turn-On Delay Time $V_{CS} = 0 \text{ V to } 10 \text{ V}, V_{CS} = 50 \text{ V}, 0 \text{ D} = 50 \text{ V}, 0 \text{ D} = 50 \text{ V}, 0$

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0 %.

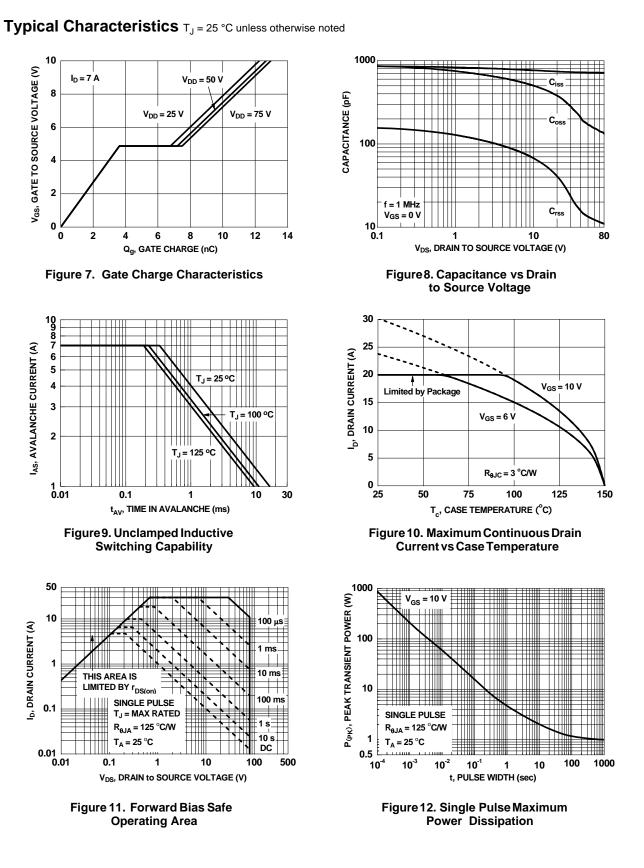
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3. Starting T_J = 25 $^{o}C;$ N-ch: L = 1 mH, I_{AS} = 12 A, V_{DD} = 72 V, V_{GS} = 10 V.

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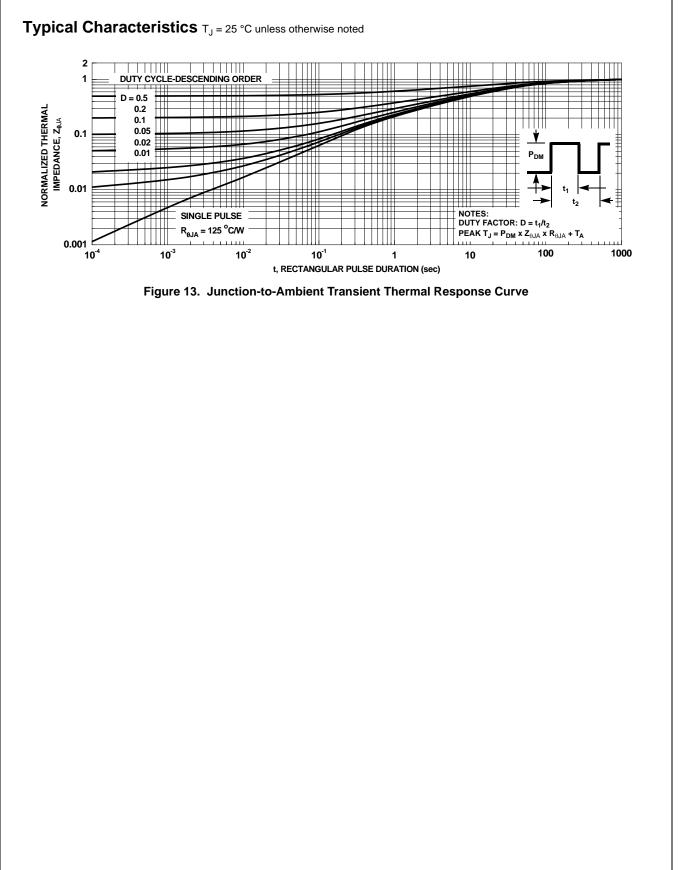
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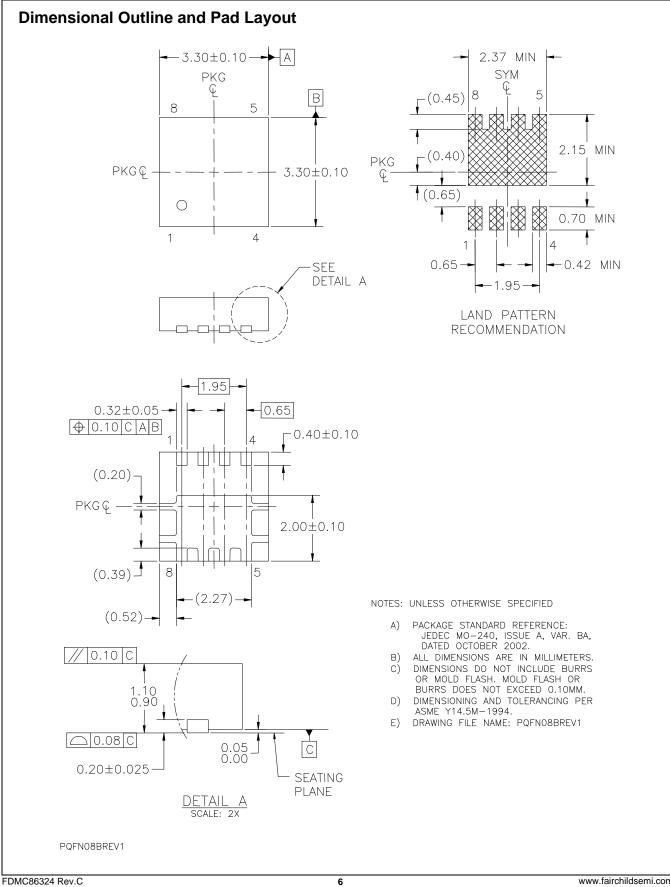
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FDMC86324 N-Channel Power Trench[®] MOSFET



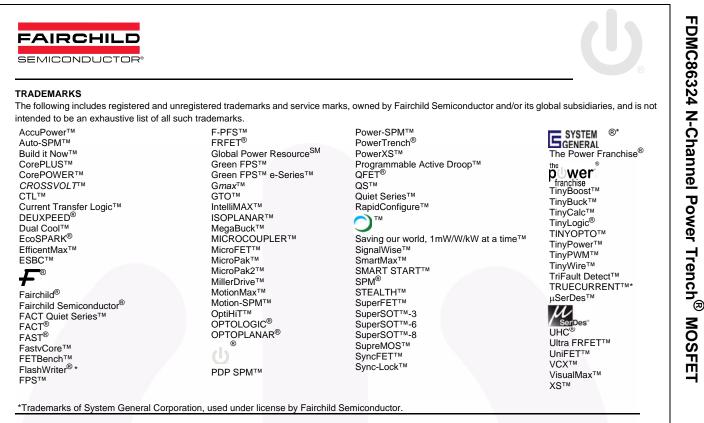
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